

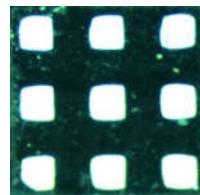
WS7802F

0.1GHz – 3GHz SPDT Antenna Switch

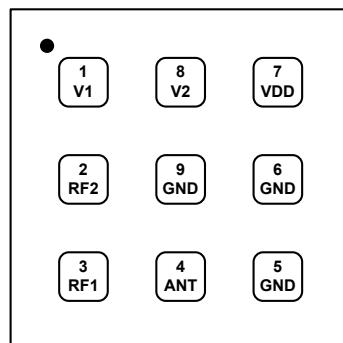
<http://www.sh-willsemi.com>

Descriptions

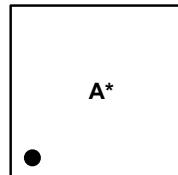
The WS7802F is a CMOS silicon-on-insulator (SOI), single-pole, double-throw (SPDT) switch. The device is optimized for the applications of WCDMA/LTE receiver and antenna switch for multimode systems. The high linearity performance and low insertion loss make the device an ideal choice for WCDMA/LTE handset and data card applications. The WS7802F switch is provided in a compact Land Grid Array (LAG) 1.15 x 1.15 mm² package.



LGA 1.15X1.15-9L (Bottom view)



Pin configuration (Top view)



A = Device code

* = Month code (A~Z)

Marking(Top view)

- Small, low profile package 1.15mm x 1.15mm x 0.45mm
- Working frequency up to 3GHz
- Very low insertion loss
- Excellent isolation performance
- Low power consumption
- Exceptional linearity performance for WCDMA/LTE application
- Low harmonic generation
- Very good ESD performance

Applications

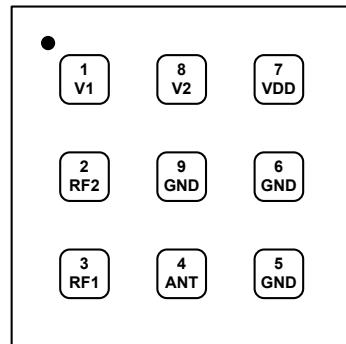
- Cell phones
- Tablets
- Other RF front-end modules

Order information

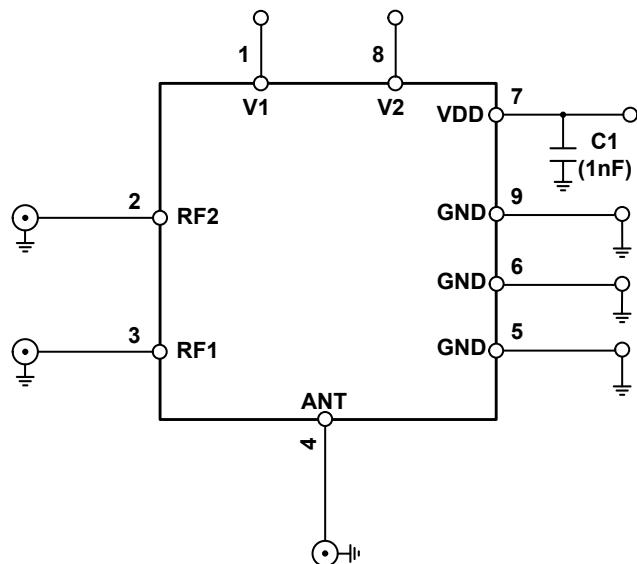
Device	Package	Shipping
WS7802F-9/TR	LGA 1.15X1.15-9L	3000/Reel&Tape

Pinning information

Pin	Function	Description	Transparent top view
1	V1	DC control voltage1	
2	RF2	RF port 2	
3	RF1	RF port 1	
4	ANT	RF common (antenna) port	
5	GND	Ground	
6	GND	Ground	
7	VDD	DC power supply	
8	V2	DC control voltage2	
9	GND	Ground	



Application information



Recommended operating conditions

Parameters	Conditions	Specifications			Unit
		Min.	Typ.	Max.	
ESD Rating					
ESD All Pins	HBM, JESD22-A114			1000	V
Power Supply					
Power Supply Voltage	Operating Voltage	2.4	2.8	3.0	V
Power Supply Current	VDD≤3.0V	20	28	40	µA
Control Voltage					
Logic Control "Low"		0	0	0.3	V
Logic Control "High"		1.2	1.8	2.7	V
RF Impedance					
RF Port Input and Output Impedance			50		Ω

Absolute maximum ratings

Maximum ratings are absolute ratings, exceeding only one of these values may cause irreversible damage to the integrated circuit.

Items	Value	Unit
VDD Voltage	-0.3 to +3.0	V
Control Voltage	-0.3 to +2.7	V
Maximum Input Power @ RF ports	26@0.88GHz, 32@2.0GHz	dBm
Operation Temperature	-40 to +85	°C
Storage Temperature	-65 to +150	°C

Characteristics (RF spec)

Normal test condition unless other-wise stated. All unused ports are 50Ω terminated. $V_{DD}=2.8V$, Temp= $+25^{\circ}C$. $P_{IN}=0dBm$.

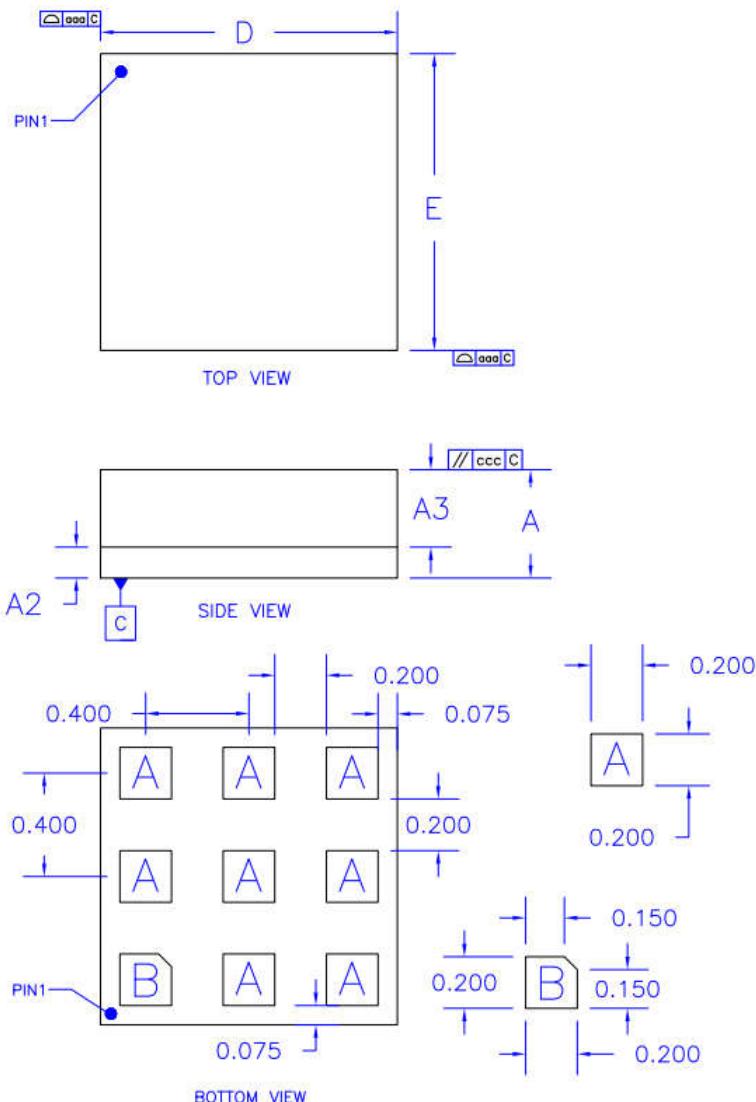
Parameters	Conditions	Specifications			Unit
		Min.	Typ.	Max.	
Insertion Loss (RF1/RF2)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz		0.40 0.45 0.50	0.50 0.60 0.65	dB
Isolation (ANT to RF1/RF2)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz	32 25 20			dB
Return Loss (ANT/RF1/RF2)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz	24 20 18			dB
Second Harmonics (RF1/RF2)	$P_{IN}=+26dBm@0.88G$		80		dBc
Third Harmonics (RF1/RF2)	$P_{IN}=+26dBm@0.88G$		66		dBc
0.1dB Compression Point (RF1/RF2)	@0.88GHz @2.00GHz		24 30		dBm
3 rd Order Input Intercept Point (RF1/RF2)	$P_2= +20dBm$, $P_1= -15dBm$, Note 1		55		dBm

Note 1: $f_2=836.5MHz$, $f_1=791.5MHz$, $f_{IMD3}=881.5MHz$

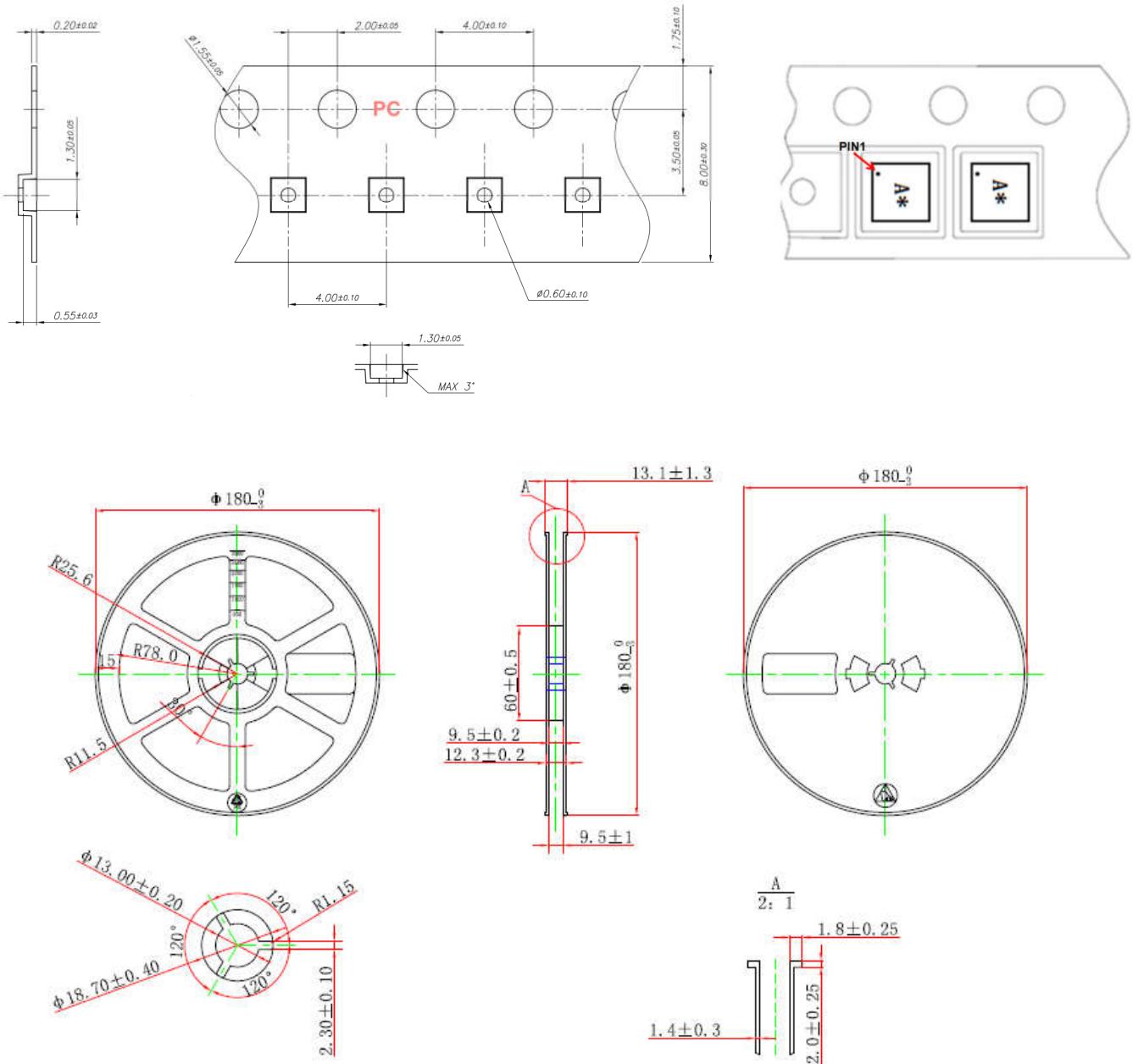
Truth Table for Operation

Mode	V1	V2
RF1	1	0
RF2	1	1

Note: Any state other than that described in this Table places the switch into an undefined state. An undefined state will not damage the device.

Package outline dimensions
LGA 1.15X1.15-9L


SYMBOL	MILLIMETER		
	MIN	NOR	MAX
A	0.40	0.45	0.50
A2	0.09	0.12	0.15
A3	0.31	0.33	0.35
D	1.10	1.15	1.20
E	1.10	1.15	1.20
aaa		0.10	
ccc		0.05	

Tape reel information

Notes:

1. 10 sprocket hole pitch cumulative tolerance ± 0.2
2. Camber not to exceed 1mm in 250mm
3. Material: PolyCarbonate
4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Pocket center and pocket hole center must be same position.
7. ESD: $10E5 \sim 10E9$